

## Voltage Detector ( $V_{DF}=1.6V\sim 5.0V$ )

### GENERAL DESCRIPTION

The XC6101~XC6107, XC6111~XC6117 series are groups of high-precision, low current consumption voltage detectors with manual reset input and watchdog functions incorporating CMOS process technology. The series consist of a reference voltage source, delay circuit, comparator, and output driver. With the built-in delay circuit, the XC6101 ~ XC6107, XC6111 ~ XC6117 series do not require any external components to output signals with release delay time. Moreover, with the manual reset function, reset can be asserted at any time. The ICs produce two types of output;  $V_{DFL}$  (low when detected) and  $V_{DFH}$  (high when detected). With the XC6101 ~ XC6105, XC6111 ~ XC6115 series, the WD pin can be left open if the watchdog function is not used. Whenever the watchdog pin is opened, the internal counter clears before the watchdog timeout occurs. Since the manual reset pin is internally pulled up to the  $V_{IN}$  pin voltage level, the ICs can be used by leaving the manual reset pin unconnected if the pin is unused. The detect voltages are internally fixed 1.6V ~ 5.0V in increments of 0.1V, using laser trimming technology. Six watchdog timeout periods are available in a range from 6.25ms to 1.6s. Seven release delay times are available in a range from 3.13ms to 1.6s.

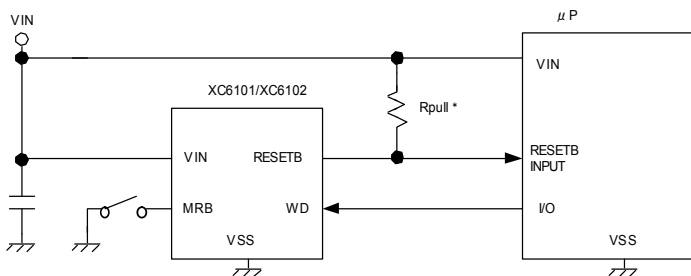
### APPLICATIONS

- Microprocessor reset circuits
- Memory battery backup circuits
- System power-on reset circuits
- Power failure detection

### FEATURES

- Detect Voltage Range** : 1.6V ~ 5.0V,  $\pm 2\%$  (0.1V increments)
- Hysteresis Width** :  $V_{DF} \times 5\%$ , TYP. (XC6101~XC6107)  
 $V_{DF} \times 0.1\%$ , TYP. (XC6111~XC6117)
- Operating Voltage Range** : 1.0V ~ 6.0V
- Detect Voltage Temperature Coefficient** :  $\pm 100\text{ppm}/^\circ\text{C}$  (TYP.)
- Output Configuration** : N-channel open drain, CMOS
- Reset Output Options** :  $V_{DFL}$  (Low when detected)  
 $V_{DFH}$  (High when detected)
- Watchdog Function** : Watchdog input WD;  
If it remains either high or low for the duration of the watchdog timeout period, a reset is asserted.
- Manual Reset Function** : Manual Reset Input MRB;  
When it changes from high to low, a reset is asserted.
- Release Delay Time** : 1.6s, 400ms, 200ms, 100ms, 50ms, 25ms, 3.13ms (TYP.)
- Watchdog Timeout Period** : 1.6s, 400ms, 200ms, 100ms, 50ms, 6.25ms (TYP.)
- Packages** : SOT-25, USP-6C
- Environmentally Friendly** : EU RoHS Compliant, Pb Free

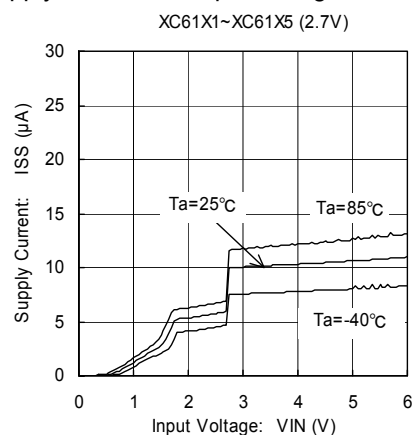
### TYPICAL APPLICATION CIRCUIT



\* Not necessary with CMOS output products.

### TYPICAL PERFORMANCE CHARACTERISTICS

Supply Current vs. Input Voltage

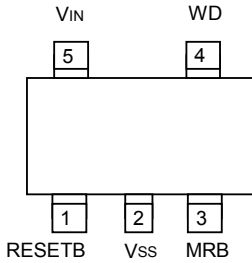


\* 'x' represents both '0' and '1'. (ex. XC61x1 XC6101 and XC6111)

## PIN CONFIGURATION

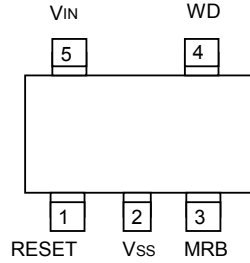
### SOT-25

XC6101, XC6102 Series  
XC6111, XC6112 Series



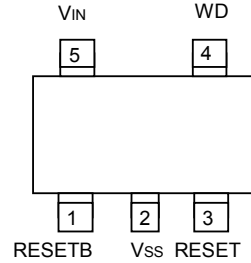
SOT-25 (TOP VIEW)

XC6103 & XC6113 Series



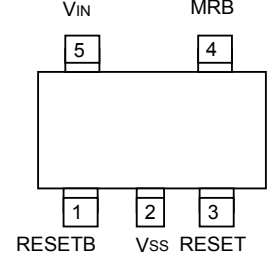
SOT-25 (TOP VIEW)

XC6104, XC6105 Series  
XC6114, XC6115 Series



SOT-25 (TOP VIEW)

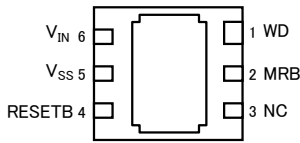
XC6106, XC6107 Series  
XC6116, XC6117 Series



SOT-25 (TOP VIEW)

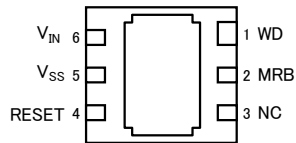
### USP-6C

XC6101, XC6102 Series  
XC6111, XC6112 Series



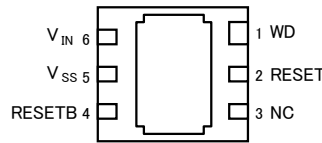
USP-6C (BOTTOM VIEW)

XC6103 & XC6113 Series



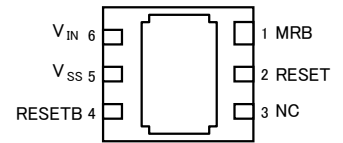
USP-6C (BOTTOM VIEW)

XC6104, XC6105 Series  
XC6114, XC6115 Series



USP-6C (BOTTOM VIEW)

XC6106, XC6107 Series  
XC6116, XC6117 Series



USP-6C (BOTTOM VIEW)

\* The dissipation pad for the USP-6C package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the Vss (No.5) pin.

## PIN ASSIGNMENT

PIN NUMBER								PIN NAME	FUNCTION
XC6101, XC6102		XC6103		XC6104, XC6105		XC6106, XC6107			
XC6111, XC6112		XC6113		XC6114, XC6115		XC6116, XC6117			
SOT-25	USP-6C	SOT-25	USP-6C	SOT-25	USP-6C	SOT-25	USP-6C		
1	4	-	-	1	4	1	4	RESETB	Reset Output (VDFL: Low Level When Detected)
2	5	2	5	2	5	2	5	Vss	Ground
3	2	3	2	-	-	4	1	MRB	Manual Reset
4	1	4	1	4	1	-	-	WD	Watchdog
5	6	5	6	5	6	5	6	VIN	Power Input
-	-	1	4	3	2	3	2	RESET	Reset Output (VDFH: High Level When Detected)

## PRODUCT CLASSIFICATION

Selection Guide

SERIES		WATCHDOG	MANUAL RESET	RESET OUTPUT	
				V <sub>DFL</sub> (RESETB)	V <sub>DFH</sub> (RESET)
XC6101	XC6111	Available	Available	CMOS	-
XC6102	XC6112	Available	Available	N-channel open drain	-
XC6103	XC6113	Available	Available	-	CMOS
XC6104	XC6114	Available	Not Available	CMOS	CMOS
XC6105	XC6115	Available	Not Available	N-channel open drain	CMOS
XC6106	XC6116	Not Available	Available	CMOS	CMOS
XC6107	XC6117	Not Available	Available	N-channel open drain	CMOS

### Ordering Information

XC61 \_\_\_\_\_ - <sup>(\*)</sup>

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
	Hysteresis Width	0	V <sub>DF</sub> x 5% (TYP.) with hysteresis
		1	V <sub>DF</sub> x 0.1% (TYP.) without hysteresis
	Functions and Type of Reset Output	1 ~ 7	Watchdog and manual functions, and reset output type as per Selection Guide in the above chart
	Release Delay Time *	A	3.13ms (TYP.)
		B	25ms (TYP.)
		C	50ms (TYP.)
		D	100ms (TYP.)
		E	200ms (TYP.)
		F	400ms (TYP.)
		H	1.6s (TYP.)
	Watchdog Timeout Period	0	No WD timeout period for XC6106, XC6107, XC6116, XC6117 Series
		1	6.25ms (TYP.)
		2	50ms (TYP.)
		3	100ms (TYP.)
		4	200ms (TYP.)
		5	400ms (TYP.)
		6	1.6s (TYP.)
	Detect Voltage	16 ~ 50	Detect voltage ex.) 4.5V: 4, 5
-	Packages Taping Type <sup>(*)</sup>	MR	SOT-25
		MR-G	SOT-25
		ER	USP-6C
		ER-G	USP-6C

\* Please set the release delay time shorter than or equal to the watchdog timeout period.

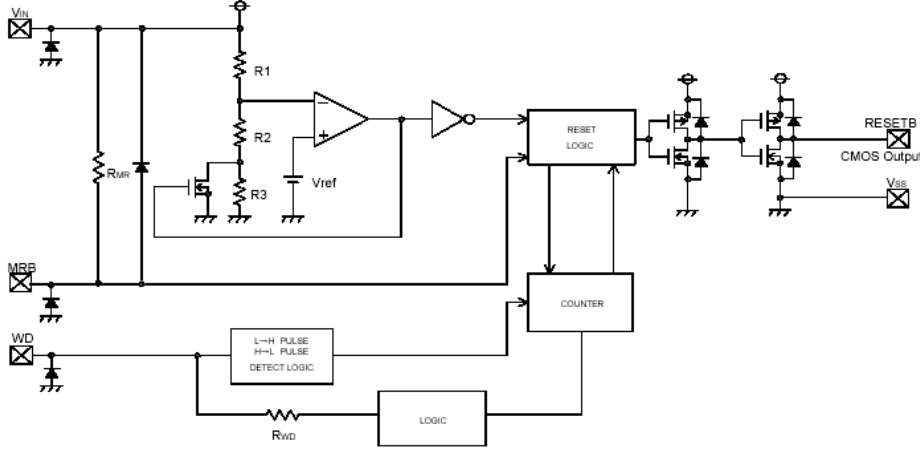
ex.) XC6101D427MR or XC6101D327MR

<sup>(\*)</sup> The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

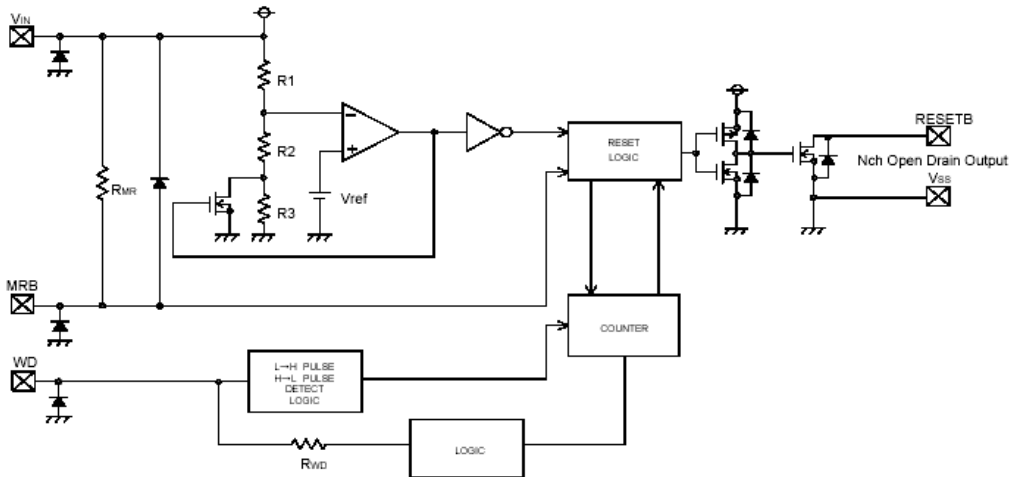
<sup>(2)</sup> The device orientation is fixed in its embossed tape pocket. For reverse orientation, please contact your local Torex sales office or representative. (Standard orientation: R- , Reverse orientation: L- )

BLOCK DIAGRAMS

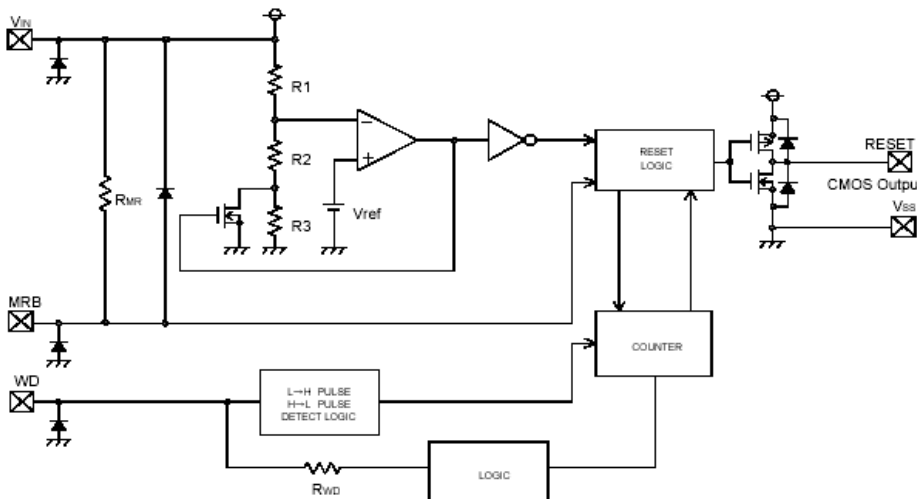
XC6101, XC6111 Series



XC6102, XC6112 Series

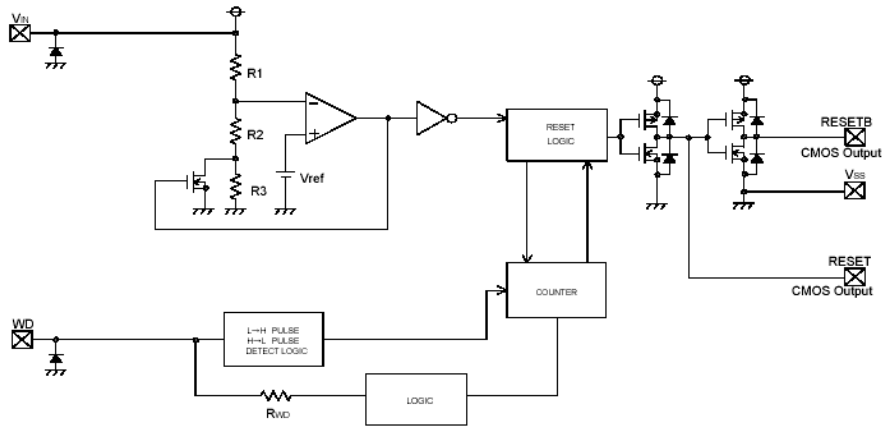


XC6103, XC6113 Series

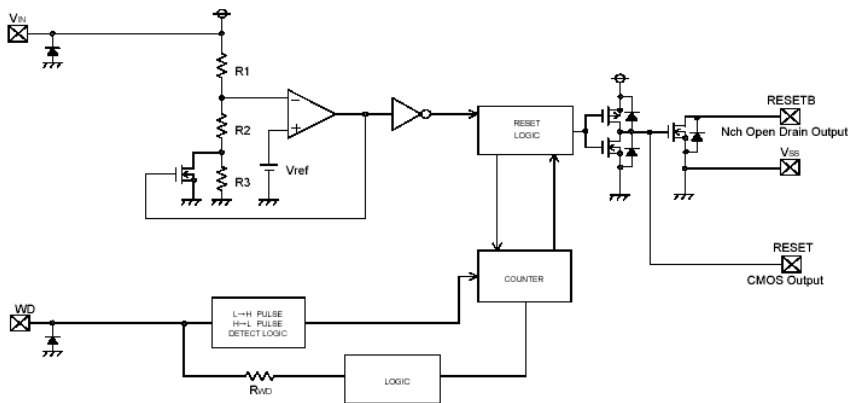


## BLOCK DIAGRAMS (Continued)

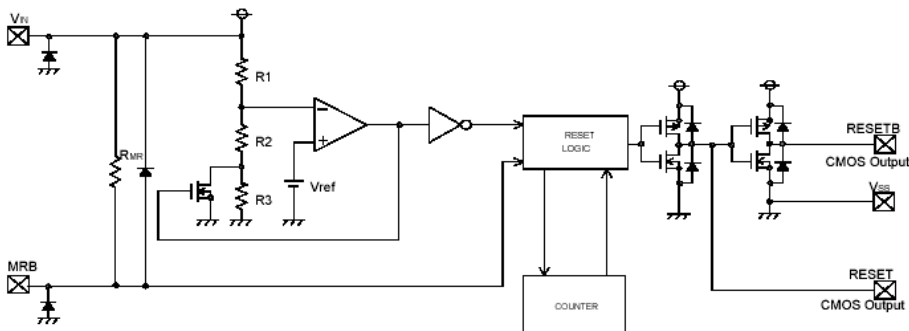
XC6104, XC6114 Series



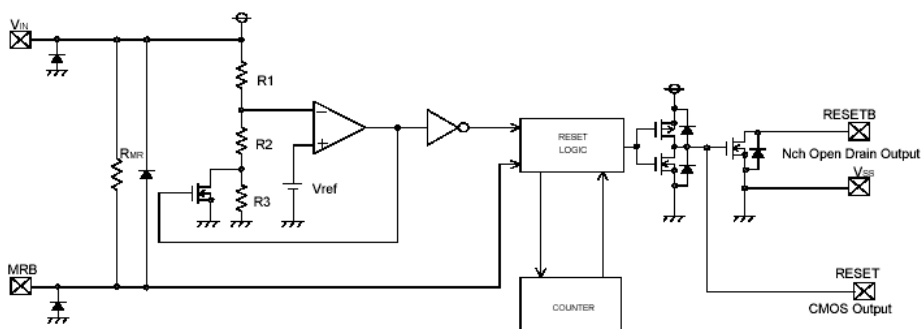
XC6105, XC6115 Series



XC6106, XC6116 Series



XC6107, XC6117 Series



ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V <sub>IN</sub>	V <sub>SS</sub> -0.3 ~ 7.0	V
		MRB	V <sub>SS</sub> -0.3 ~ V <sub>IN</sub> +0.3 7.0	V
		WD	V <sub>SS</sub> -0.3 ~ 7.0	V
Output Current		I <sub>OUT</sub>	20	mA
Output Voltage	CMOS Output	RESETB/RESET	V <sub>SS</sub> -0.3 ~ V <sub>IN</sub> +0.3 7.0	V
	N-ch Open Drain Output	RESETB	V <sub>SS</sub> -0.3 ~ 7.0	
Power Dissipation	SOT-25	P <sub>d</sub>	250	mW
	USP-6C		100	
Operational Temperature Range		T <sub>a</sub>	-40 ~ +85	°C
Storage Temperature Range		T <sub>stg</sub>	-40 ~ +125	°C

## ELECTRICAL CHARACTERISTICS

XC6101~XC6107, XC6111~XC6117 Series

Ta = 25 °C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT	
Detect Voltage	VDFL VDFH		VDF(T) × 0.98	VDF(T)	VDF(T) × 1.02	V		
Hysteresis Width XC6101~XC6107 <sup>(*)1</sup>	VHYS		VDF × 0.02	VDF × 0.05	VDF × 0.08	V		
Hysteresis Width XC6111~XC6117 <sup>(*)2</sup>	VHYS		0	VDF × 0.001	VDF × 0.01	V		
Supply Current	ISS	XC61X1/XC61X2/XC61X3 XC61X4/XC61X5 <sup>(*)3</sup> (The MRB & the WD Pin: No connection)	VIN=VDF(T)×0.9V	-	5	11	μA	
			VIN=VDF(T)×1.1V	-	10	16		
			VIN=6.0V	-	12	18		
		XC61X6/XC61X7 <sup>(*)3</sup> (The MRB Pin: No connection)	VIN=VDF(T)×0.9V	-	4	10		
			VIN=VDF(T)×1.1V	-	8	14		
			VIN=6.0V	-	10	16		
Operating Voltage	VIN		1.0	-	6.0	V		
VDFL Output Current (RESETB)	IRBOUT	N-ch. VDS = 0.5V	VIN=1.0V	0.15	0.5	-	mA	
			VIN=2.0V (VDFL(T) > 2.0V)	2.0	2.5	-		
			VIN=3.0V (VDFL(T) > 3.0V)	3.0	3.5	-		
			VIN=4.0V (VDFL(T) > 4.0V)	3.5	4.0	-		
VDFH Output Current (RESET)	IROUT	CMOS, P-ch VDS = 0.5V	VIN=6.0V	-	-1.1	-0.8	mA	
			N-ch VDS = 0.5V	VIN=1.0V	-	-0.08		-0.02
				VIN=2.0V (VDFH(T) > 2.0V)	-	-0.50		-0.30
				VIN=3.0V (VDFH(T) > 3.0V)	-	-0.75		-0.55
				VIN=4.0V (VDFH(T) > 4.0V)	-	-0.95		-0.75
Temperature Coefficient	VDF / (Ta · VDF)	-40 °C ≤ Topr ≤ 85 °C	-	±100	-	ppm/ °C		
Release Delay Time (VDF ≤ 1.8V)	TDR	Time until VIN is increased from 1.0V to 2.0V and attains to the release time level, and the Reset output pin inverts.	2	3.13	5	ms		
			18	25	31			
			37	50	63			
			75	100	125			
			150	200	250			
			300	400	500			
			1200	1600	2000			
Release Delay Time (VDF ≥ 1.9V)	TDR	Time until VIN is increased from 1.0V to (VDF×1.1V) and attains to the release time level, and the Reset output pin inverts.	2	3.13	5	ms		
			18	25	31			
			37	50	63			
			75	100	125			
			150	200	250			
			300	400	500			
			1200	1600	2000			
Detect Delay Time	TDF	Time until VIN is decreased from 6.0V to 1.0V and attains to the detect voltage level, and the Reset output pin detects while the WD pin left opened.	-	3	30	μs		
VDFL/VDFH CMOS Output Leak Current	I <sub>LEAK</sub>	VIN=6.0V, RESETB=6.0V (VDFL) VIN=6.0V, RESET=0V (VDFH)	-	0.01	-	μA		
VDFL N-ch Open Drain Output Leak Current	I <sub>LEAK</sub>	VIN=6.0V, RESETB=6.0V	-	0.01	0.10	μA		

NOTE:

\*1: XC6101~XC6107 (with hysteresis)

\*2: XC6111~XC6117 (without hysteresis)

\*3: 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

\*4: VDF(T): Setting detect voltage

\*5: If only "VDF" is indicated, it represents both VDFL (low when detected) and VDFH (high when detected).

## ELECTRICAL CHARACTERISTICS (Continued)

XC6101~XC6105, XC6111~XC6115 Series

Ta = 25 °C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Watchdog Timeout Period (VDF≤1.8V)	T <sub>WD</sub>	Time until V <sub>IN</sub> increases from 1.0V to 2.0V and the Reset output pin is released to go into the detection state. (WD=V <sub>SS</sub> )	4.25	6.25	8.25	ms	
			37	50	63		
			75	100	125		
			150	200	250		
			300	400	500		
			1200	1600	2000		
Watchdog Timeout Period (VDF≥1.9V)	T <sub>WD</sub>	Time until V <sub>IN</sub> increases from 1.0V to (VDF×1.1V) and the Reset output pin is released to go into the detection state. (WD=V <sub>SS</sub> )	4.25	6.25	8.25	ms	
			37	50	63		
			75	100	125		
			150	200	250		
			300	400	500		
			1200	1600	2000		
Watchdog Minimum Pulse Width	T <sub>WDIN</sub>	V <sub>IN</sub> =6.0V, Apply pulse from 6.0V to 0V to the WD pin.	300	-	-	ns	
Watchdog High Level Voltage	V <sub>WDH</sub>	V <sub>IN</sub> =V <sub>DF</sub> × 1.1V ~ 6.0V	V <sub>IN</sub> × 0.7	-	6	V	
Watchdog Low Level Voltage	V <sub>WDL</sub>	V <sub>IN</sub> =V <sub>DF</sub> × 1.1V ~ 6.0V	0	-	V <sub>IN</sub> × 0.3	V	
Watchdog Input Current	I <sub>WD</sub>	V <sub>IN</sub> =6.0V, V <sub>WD</sub> =6.0V (Avg. when peak)	-	12	19	μA	
		V <sub>IN</sub> =6.0V, V <sub>WD</sub> =0V (Avg. when peak)	-19	-12	-		
Watchdog Input Resistance	R <sub>WD</sub>	V <sub>IN</sub> =6.0V, V <sub>WD</sub> =0V, R <sub>WD</sub> =V <sub>IN</sub> / I <sub>WD</sub>	315	500	880	kΩ	

XC6101 ~ XC6103, XC6106 ~ XC6107, XC6111 ~ XC6113, XC6116 ~ XC6117 Series

Ta = 25 °C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
MRB High Level Voltage	V <sub>MRH</sub>	V <sub>IN</sub> =V <sub>DF</sub> ×1.1V ~ 6.0V	1.4	-	V <sub>IN</sub>	V	
MRB Low Level Voltage	V <sub>MRL</sub>	V <sub>IN</sub> =V <sub>DF</sub> ×1.1V ~ 6.0V	0	-	0.35		
MRB Pull-up Resistance	R <sub>MR</sub>	V <sub>IN</sub> =6.0V, MRB=0V, R <sub>MR</sub> =V <sub>IN</sub> / I <sub>MRB</sub>	1.6	2.4	3.0	MΩ	
MRB Minimum Pulse Width <sup>(*3)</sup> XC6101~XC6105 XC6111~XC6115	T <sub>MRIN</sub>	V <sub>IN</sub> =6.0V, Apply pulse from 6.0V to 0V to the MRB pin	2.8	-	-	μs	
MRB Minimum Pulse Width <sup>(*4)</sup> XC6106, XC6107 XC6116, XC6117	T <sub>MRIN</sub>	V <sub>IN</sub> =6.0V, Apply pulse from 6.0V to 0V to the MRB pin	1.2	-	-		

NOTE:

\*1: V<sub>DF(T)</sub>: Setting detect voltage

\*2: If only "V<sub>DF</sub>" is indicated, it represents both V<sub>DFL</sub> (low when detected) and V<sub>DFH</sub> (high when detected).

\*3: Watchdog function is available.

\*4: Watchdog function is not available.



## OPERATIONAL EXPLANATION

The XC6101~XC6107, XC6111~XC6117 series compare, using the amplifier, the voltage of the internal voltage reference source with the voltage divided by R1, R2 and R3 connected to the VIN pin. The resulting output signal from the error amplifier activates the watchdog logic, manual reset logic, delay circuit and the output driver. When the VIN pin voltage gradually falls and finally reaches the detect voltage, the RESETB pin output goes from high to low in the case of the VDFL type ICs, and the RESET pin output goes from low to high in the case of the VDFH type ICs.

### <RESETB / RESET Pin Output Signal>

\* VDFL (RESETB) type - output signal: Low when detected.

The RESETB pin output goes from high to low whenever the VIN pin voltage falls below the detect voltage, or whenever the MRB pin is driven from high to low. The RESETB pin remains low for the release delay time (TDR) after the VIN pin voltage reaches the release voltage. If neither rising nor falling signals are applied to the WD pin within the watchdog timeout period, the RESETB pin output remains low for the release delay time (TDR), and thereafter the RESET pin outputs high level signal.

\* VDFH (RESET) type – output signal: High when detected.

The RESET pin output goes from low to high whenever the VIN pin voltage falls below the detect voltage, or whenever the MRB pin is driven from high to low. The RESET pin remains high for the release delay time (TDR) after the VIN pin voltage reaches the release voltage. If neither rising nor falling signals are applied to the WD pin within the watchdog timeout period, the VOUT pin output remains high for the release delay time (TDR), and thereafter the RESET pin outputs low level signal.

### <Hysteresis>

When the internal comparator output is high, the N-Channel transistor connected in parallel to R3 is turned ON, activating the hysteresis circuit. The difference between the release and detect voltages represents the hysteresis width, as shown by the following calculations:

$$VDF \text{ (detect voltage)} = (R1+R2+R3) \times Vref(R2+R3)$$

$$VDR \text{ (release voltage)} = (R1+R2) \times Vref(R2)$$

$$VHYS \text{ (hysteresis width)} = VDR - VDF \text{ (V)}$$

$$VDR > VDF$$

\* Detect voltage (VDF) includes conditions of both VDFL (low when detected) and VDFH (high when detected).

\* Please refer to the block diagrams for R1, R2, R3 and Vref.

Hysteresis width is selectable from  $VDF \times 0.05V$  (XC6101~XC6107) or  $VDF \times 0.001V$  (XC6111~XC6117).

### <Watchdog (WD) Pin>

The XC6101~XC6107, XC6111~XC6117 series use a watchdog timer to detect malfunction or “runaway” of the microprocessor. If neither rising nor falling signals are applied from the microprocessor within the watchdog timeout period, the RESETB/RESET pin output maintains the detection state for the release delay time (TDR), and thereafter the RESET/RESETB pin output returns to the release state (Please refer to the FUNCTION CHART). The timer in the watchdog is then restarted. Six watchdog timeout period settings are available in 1.6s, 400ms, 200ms, 100ms, 50ms, 6.25ms.

### <MRB Pin>

Using the MRB voltage pin input, the RESET/RESETB pin signal can be forced to the detection state. When the MRB pin is driven from high to low, the RESETB pin output goes from high to low level signal in the case of the VDFL type ICs, and the RESET pin output goes from low to high in the case of the VDFH type. Even after the MRB pin is driven back high, the RESET/RESETB pin output maintains the detection state for the release delay time (TDR). Since the MRB pin is internally pulled up to the VIN pin voltage level, leave the MRB pin open if unused (Please refer to the FUNCTION CHART). A diode, which is an input protection element, is connected between the MRB pin and VIN pin. Therefore, if the MRB pin is applied voltage that exceeds VIN, the current will flow to VIN through the diode. Please use this IC within the stated maximum ratings ( $V_{SS}-0.3 \sim V_{IN}+0.3 \sim 7.0V$ ) on the MRB pin.

### <Release Delay Time>

Release delay time (TDR) is the time that elapses from when the VIN pin reaches the release voltage, or when the watchdog timeout period expires with no rising signal applied to the WD pin, until the RESET/RESETB pin output is released from the detection state. Seven release delay time (TDR) watchdog timeout period settings are available in 1.6s, 400ms, 200ms, 100ms, 50ms, 25ms, 3.13ms.

### <Detect Delay Time>

Detect Delay Time (TDF) is the time that elapses from when the VIN pin voltage falls to the detect voltage until the RESET/RESETB pin output goes into the detection state.

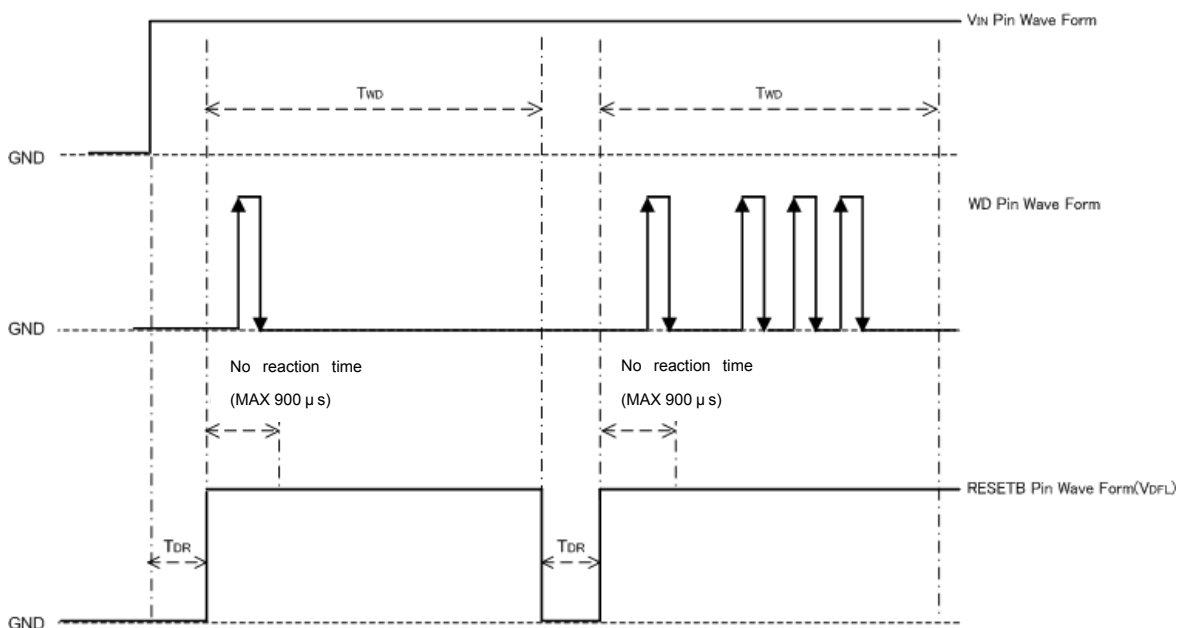


## NOTES ON USE

1. Please use this IC within the stated maximum ratings. Operation beyond these limits may cause degrading or permanent damage to the device.
2. When a resistor is connected between the  $V_{IN}$  pin and the input, the  $V_{IN}$  voltage drops while the IC is operating and a malfunction may occur as a result of the IC's through current. For the CMOS output products, the  $V_{IN}$  voltage drops while the IC is operating and malfunction may occur as a result of the IC's output current. Please be careful with using the XC6111~XC6117 series (without hysteresis).
3. In order to stabilize the IC's operations, please ensure that the  $V_{IN}$  pin's input frequency's rise and fall times are more than some  $\mu s/V$ .
4. Noise at the power supply may cause a malfunction of the watchdog operation or the circuit. In such case, please strength the line between  $V_{IN}$  and the GND pin and connect about  $0.22 \mu F$  of a capacitor between the  $V_{IN}$  pin and the GND pin.
5. Protecting against a malfunction while the watchdog time out period, an ignoring time (no reaction time) occurs to the rise and fall times. Referring to the figure below, the ignoring time (no reaction time) lasts for  $900 \mu s$  at maximum.
6. The watchdog function can be disabled by connecting a three-state device to the WDI pin as a result of the high impedance state of the WDI pin. This is effective when the watchdog function is not required, for example, during data loading to the CPU. The WDI input is internally driven through a buffer (LOGIC) and series resistor ( $R_{WD}$ ) from the watchdog counter as showed in the block diagrams of page 4 and 5. The WDI input is designed for minimizing the input current by placing the series resistor ( $R_{WD}$ ) in the maximum resistance of  $880k$ . A voltage drop occurs in proportion to the leakage current of the three-state device multiplied by the resistance value of the series resistor ( $R_{WD}$ ) when the three-state device is in the state of high impedance. The voltage level must be reaching the threshold level of the WD so that a three-state device with small leakage current should be selected.

The other series is available in the name of XC6121~XC6124 with the ON/OFF control pin for the watchdog function. When these series is used, external parts such as the three-state device is not required.

### No Reaction Time



## PIN LOGIC CONDITIONS

PIN NAME	LOGIC	CONDITIONS
VIN	H	$V_{IN} \geq V_{DF} + V_{HYS}$
	L	$V_{IN} \leq V_{DF}$
MRB	H	$MRB \geq 1.40V$
	L	$MRB \leq 0.35V$
WD	H	When keeping $W_D \geq V_{WDH}$ more than $t_{WD}$
	L	When keeping $W_D \leq V_{WDL}$ more than $t_{WD}$
	L H	$V_{WDL} \quad V_{WDH}, T_{WDIN} \geq 300ns$
	H L	$V_{WDH} \quad V_{WDH}, T_{WDIN} \geq 300ns$

NOTE:

\*1: If only "VDF" is indicated, it represents both VDFL (low when detected) and VDFH (high when detected).

\*2: For the details of each parameter, please see the electrical characteristics.

VDF: Detect Voltage  
 VHYS: Hysteresis Width  
 VWDH: WD High Level Voltage  
 VWDL: WD Low Level Voltage  
 TWDIN: WD Pulse Width  
 $t_{WD}$ : WD Timeout Period

## FUNCTION CHART

XC6101/XC61111, XC6102/6112 Series

VIN	MRB	WD	RESETB <sup>(*2)</sup>	
H	H or Open	H	Repeat detect and release (H L H)	
H		L		
H		Open		
H		L H		H
H		H L		
H	L	*1	L	
L				

XC6103/XC61113 Series

VIN	MRB	WD	RESETB <sup>(*3)</sup>	
H	H or Open	H	Repeat detect and release (L H L)	
H		L		
H		Open		
H		L H		L
H		H L		
H	L	*1	H	
L				

XC6104/XC61114, XC6105/XC6115 Series

VIN	WD	RESETB <sup>(*2)</sup>	RESET <sup>(*3)</sup>
H	H	Repeat detect and release (H L H)	Repeat detect and release (L H L)
H	L		
H	Open	H	L
H	L H		
H	H L		
L	*1	L	H

XC6106/XC61116, XC6107/XC6117 Series

VIN	MRB	RESETB <sup>(*2)</sup>	RESET <sup>(*3)</sup>
H	H or Open	H	L
H		L	H
L			

\*1: Including all logic of WD (WD=H, L, L H, H L, OPEN).

\*2: When the RESETB is High, the circuit is in the release state.

When the RESETB is Low, the circuit is in the detection state.

\*3: When the RESET is High, the circuit is in the release state.

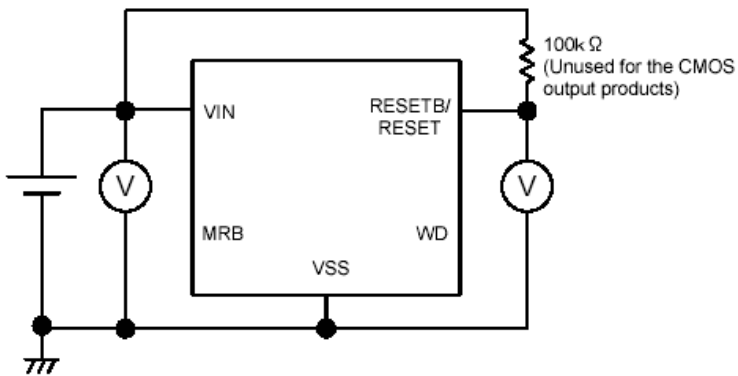
When the RESET is Low, the circuit is in the detection state.

\*4: VIN=L and MRB=H can not be combined for the rated input voltage of the MRB pin is Vss-0.3V to VIN+0.3V.

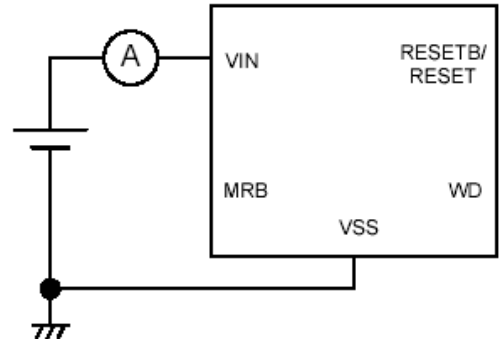
\*5: The RESET/RESETB pin becomes indefinite operation while  $0.35V < MRB < 1.4V$ .

## TEST CIRCUITS

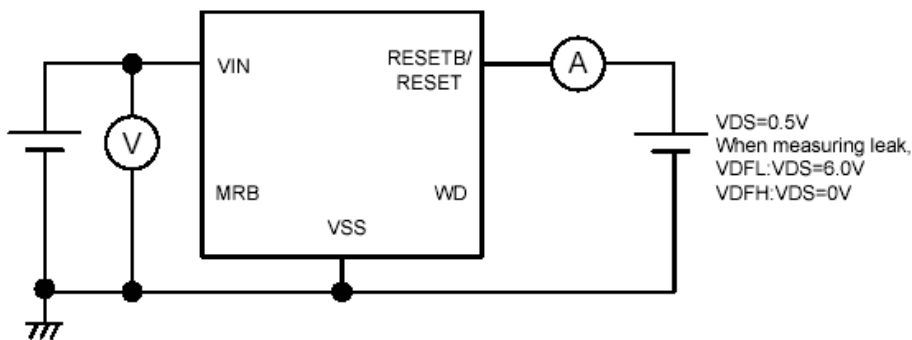
Circuit 1



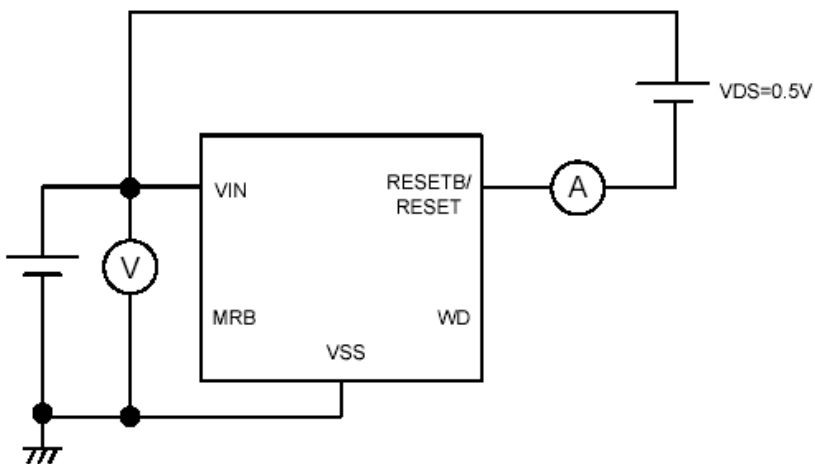
Circuit 2



Circuit 3

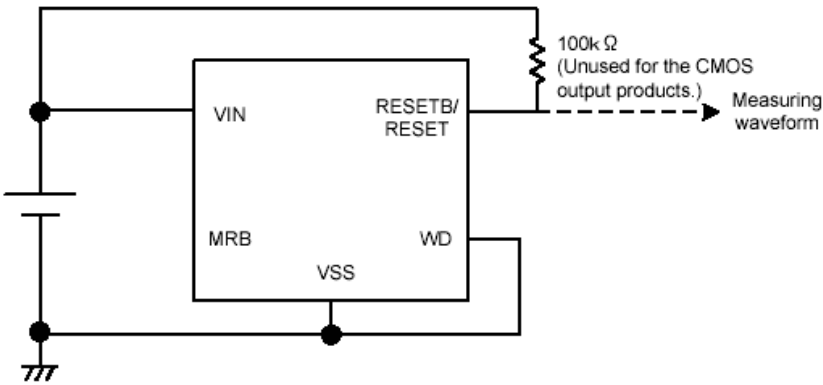


Circuit 4

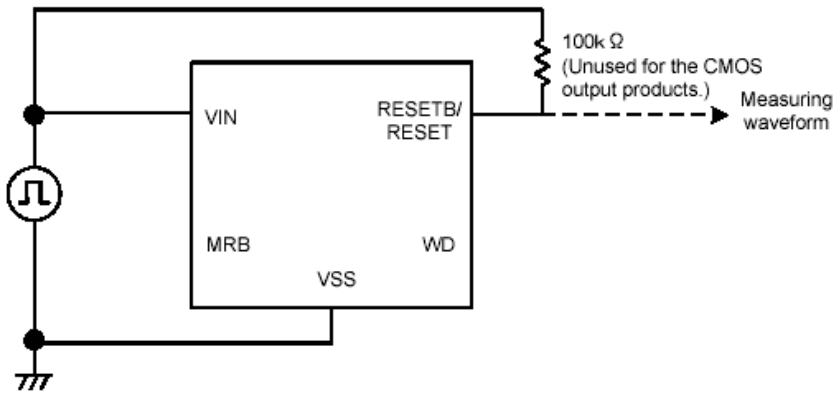


TEST CIRCUITS (Continued)

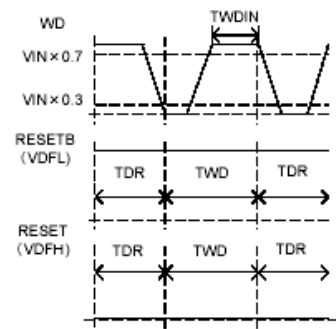
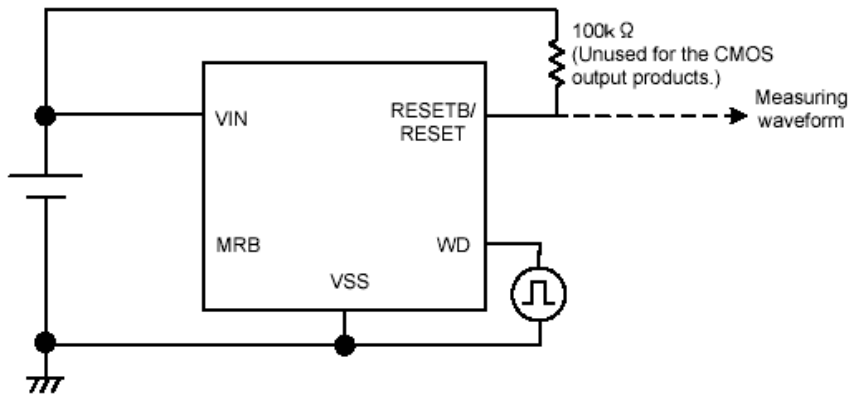
Circuit 5



Circuit 6

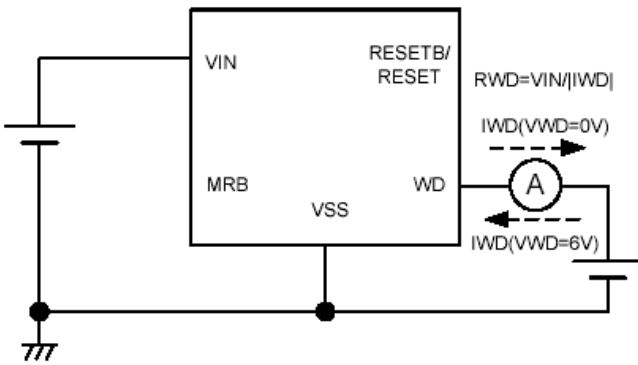


Circuit 7

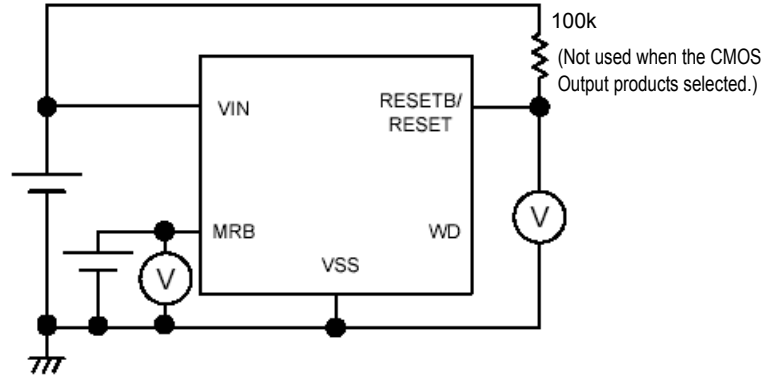


## TEST CIRCUITS (Continued)

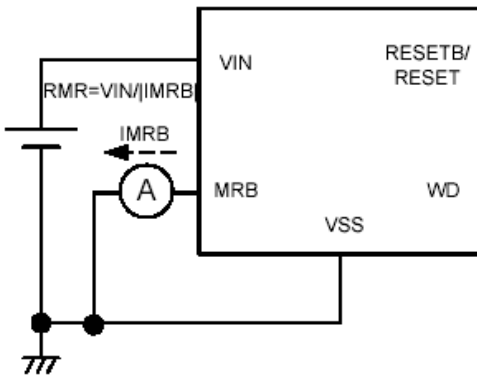
Circuit 8



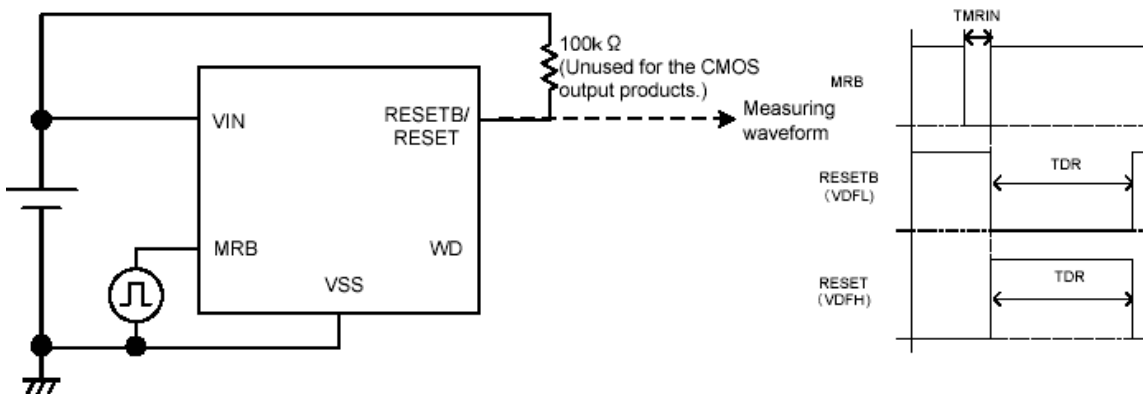
Circuit 9



Circuit 10

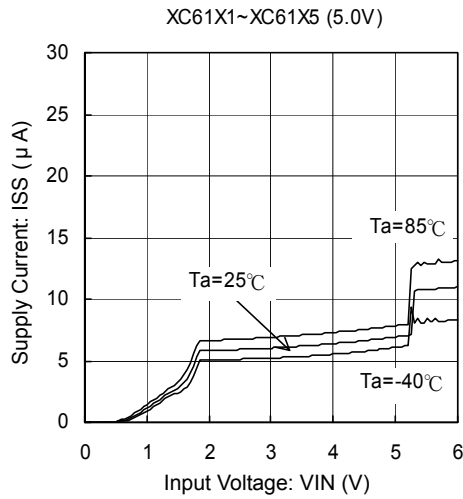
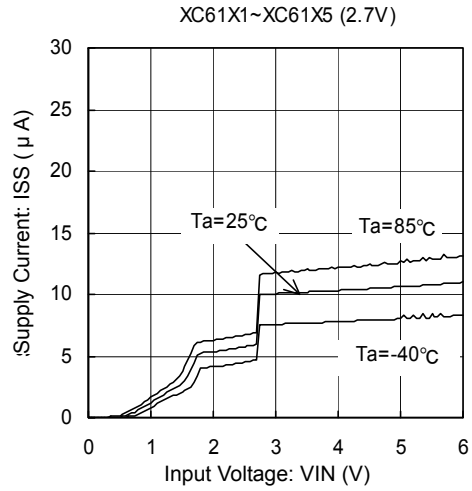
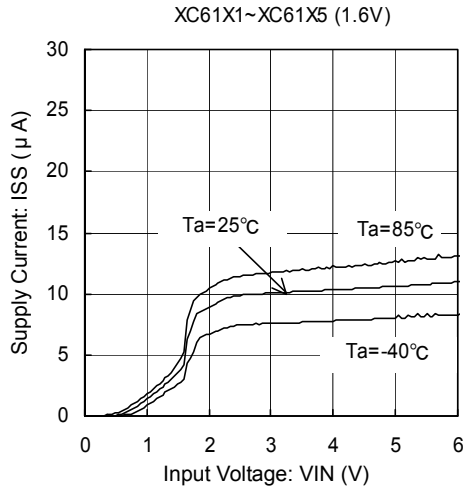


Circuit 11

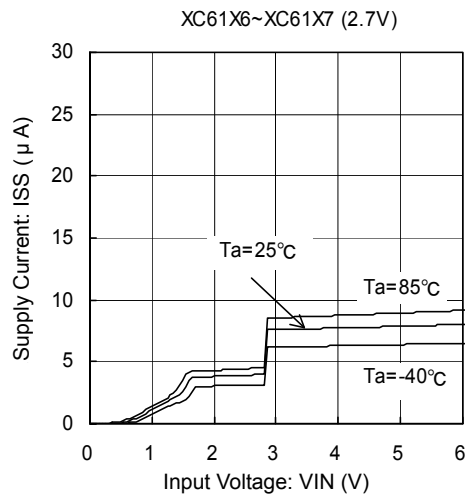
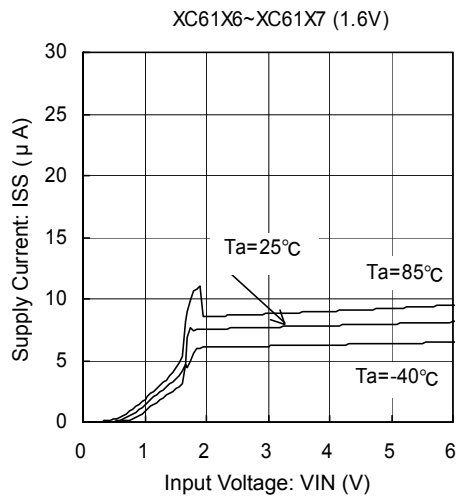


## TYPICAL PERFORMANCE CHARACTERISTICS

(1.1) Supply Current vs. Input Voltage



(1.2) Supply Current vs. Input Voltage

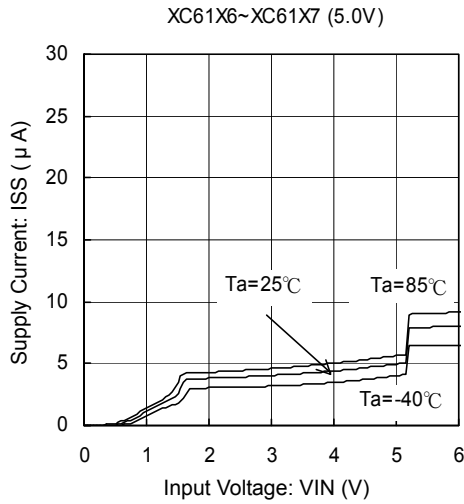


\* 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

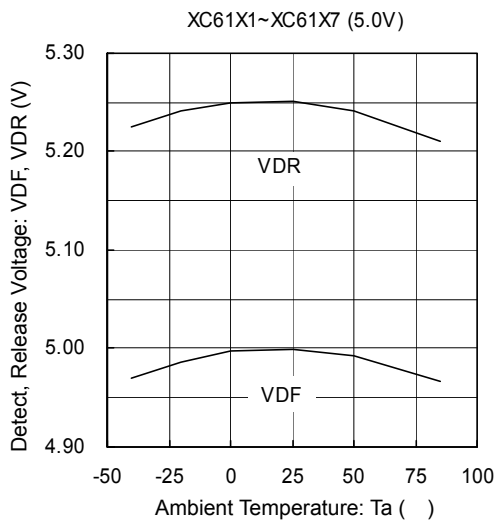
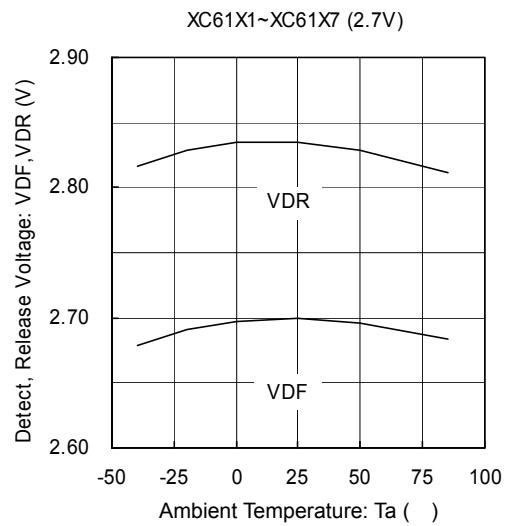
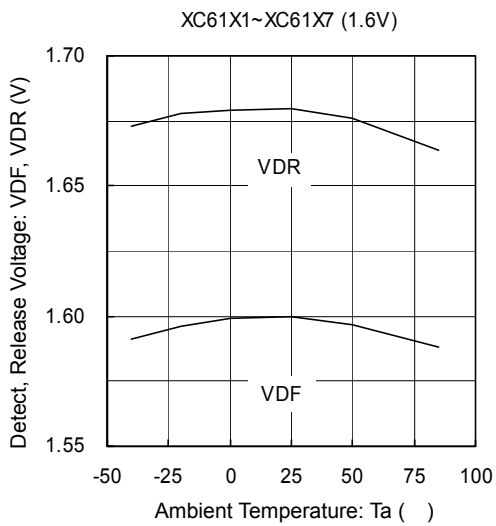


## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (1.2) Supply Current vs. Input Voltage (Continued)



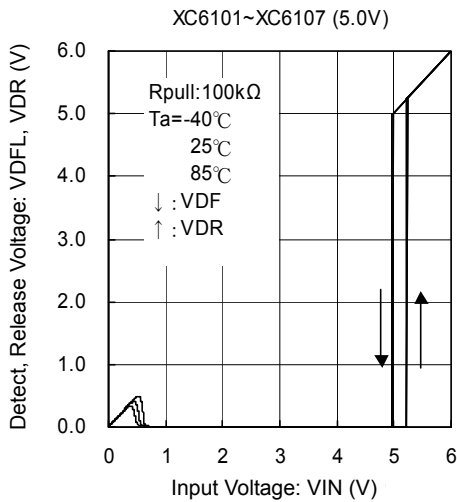
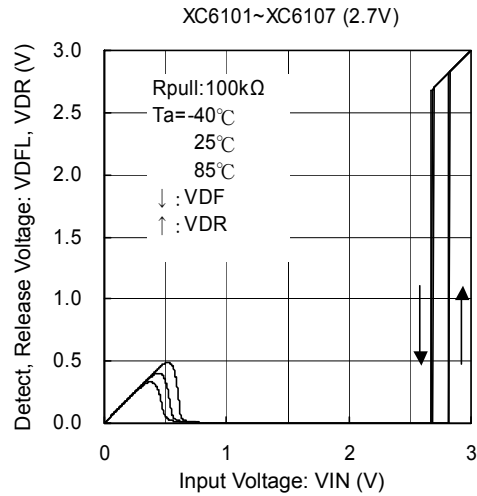
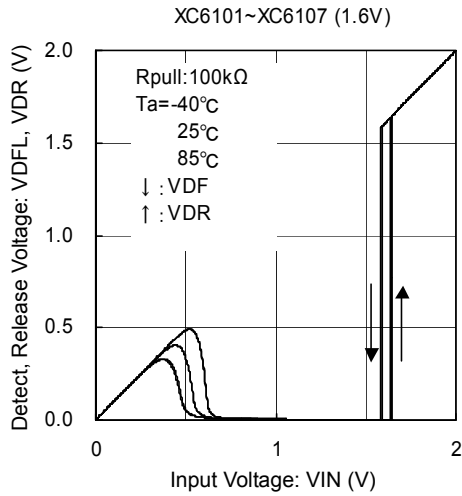
### (2) Detect, Release Voltage vs. Ambient Temperature



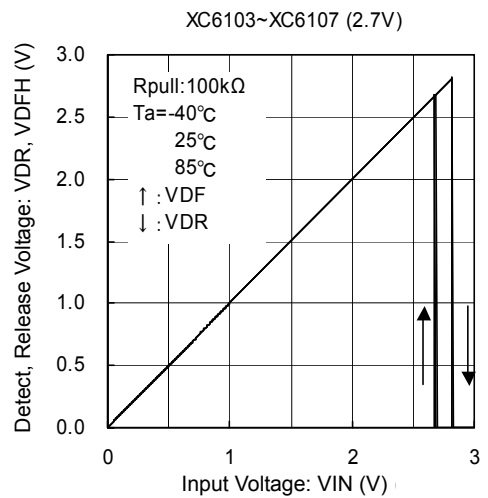
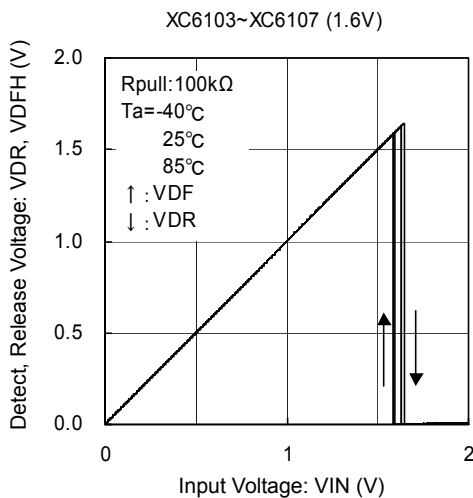
\* 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3.1) Detect, Release Voltage vs. Input Voltage (VDFL)



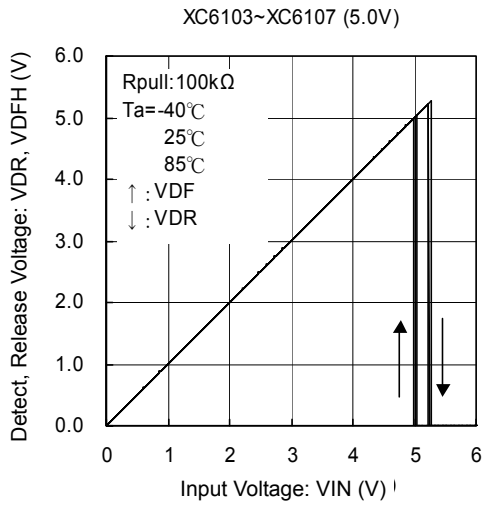
(3.2) Detect, Release Voltage vs. Input Voltage (VDFH)



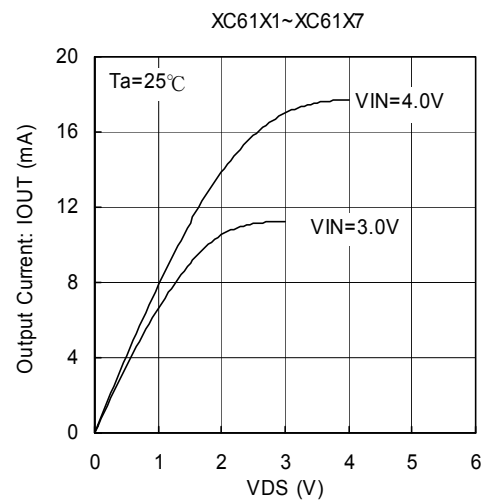
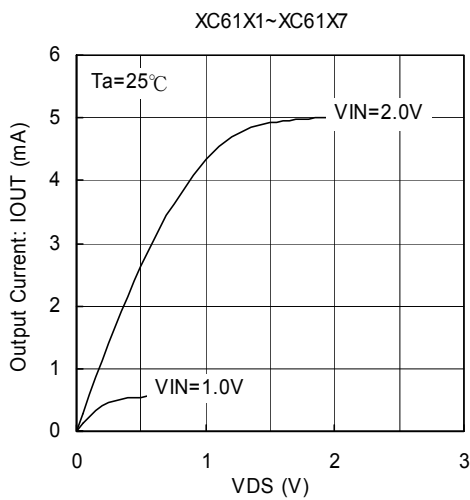
\* 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

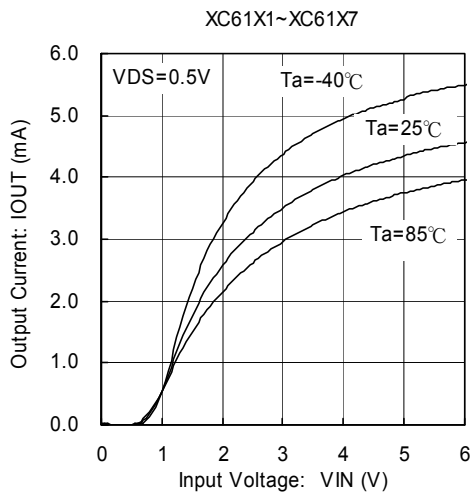
### (3.2) Detect, Release Voltage vs. Input Voltage (VDFH) (Continued)



### (4) N-ch Driver Output Current vs. VDS



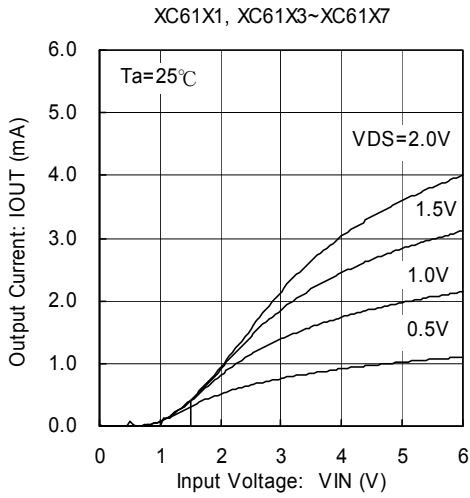
### (5) N-ch Driver Output Current vs. Input Voltage



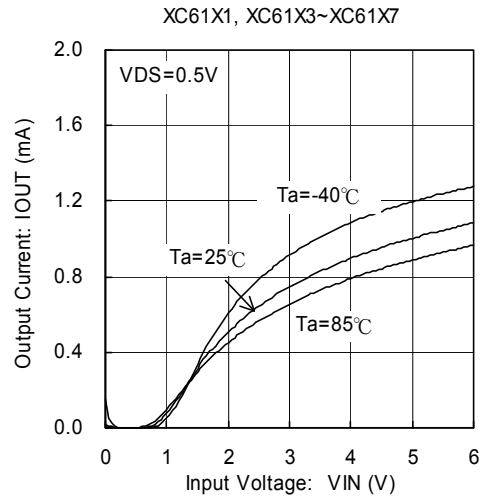
\* 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

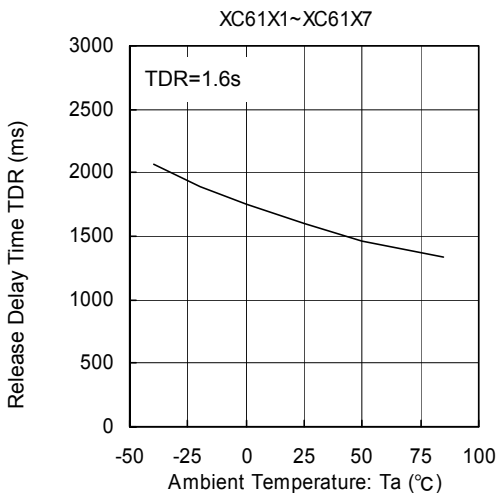
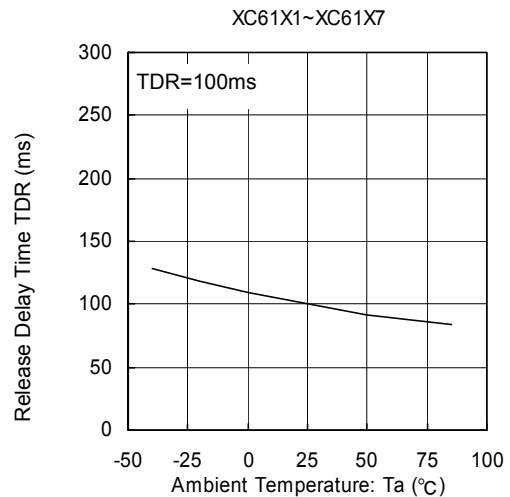
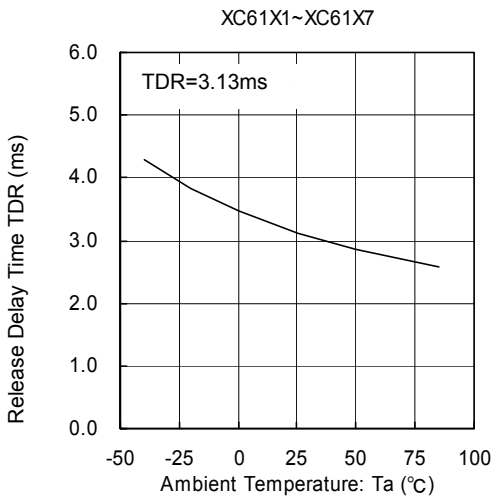
(6) P-ch Driver Output Current vs. Input Voltage 1



(7) P-ch Driver Output Current vs. Input Voltage 2



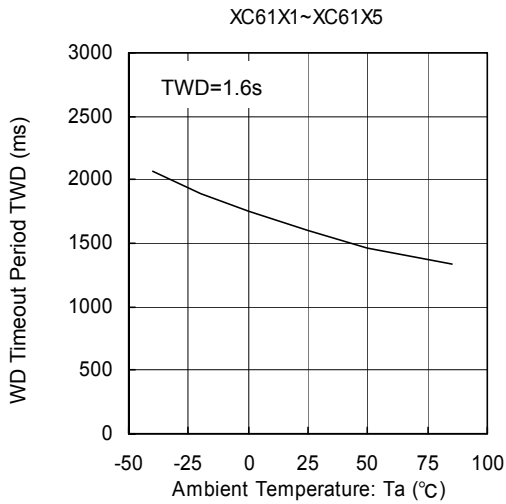
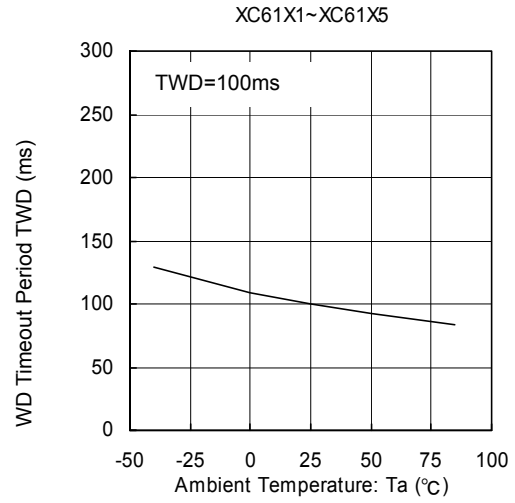
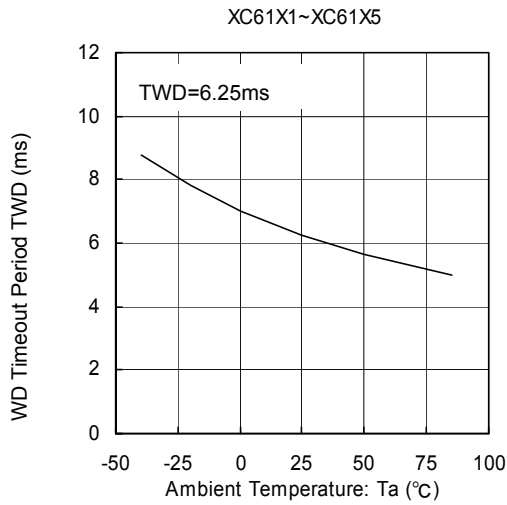
(8) Release Delay Time vs. Ambient Temperature



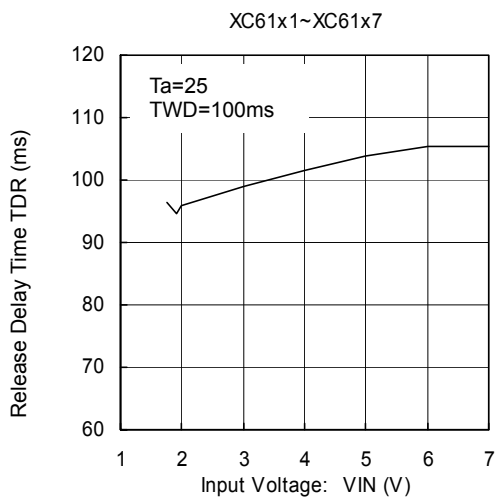
\* 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

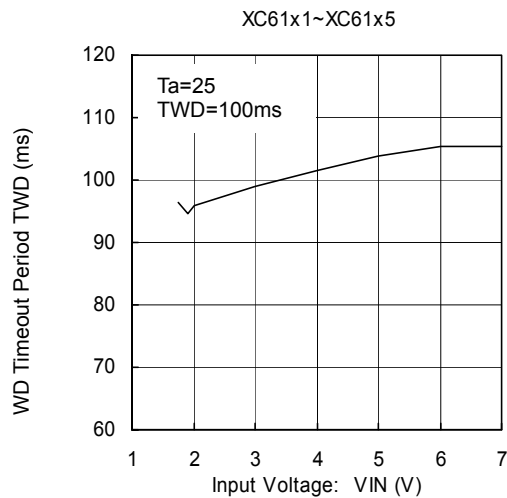
(9) Watchdog Timeout Period vs. Ambient Temperature



(10) Release Delay Time vs. Input Voltage



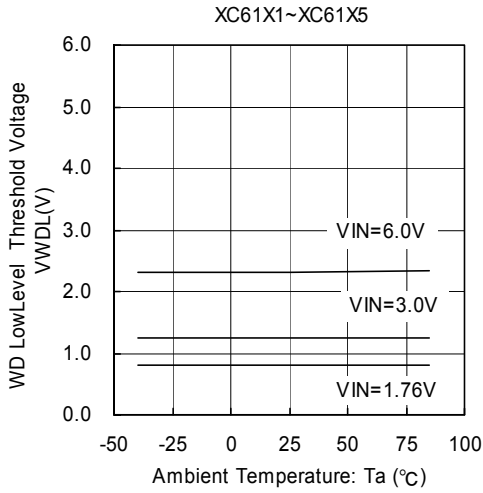
(11) Watchdog Timeout Period vs. Input Voltage



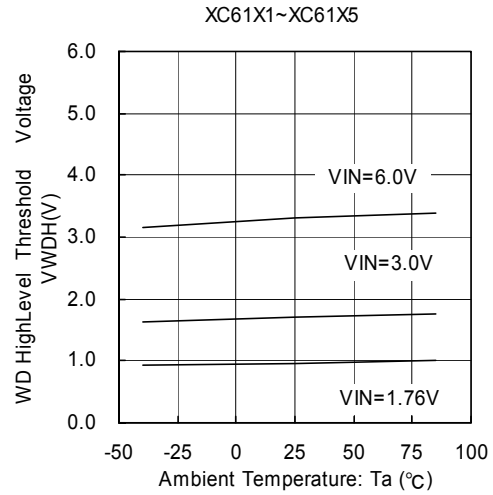
\* 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

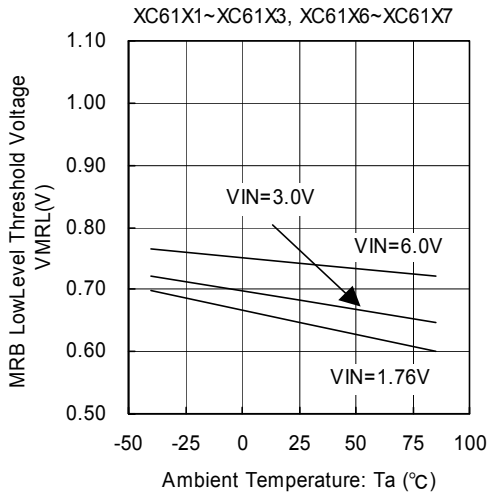
(12) Watchdog Low Level Voltage vs. Ambient Temperature



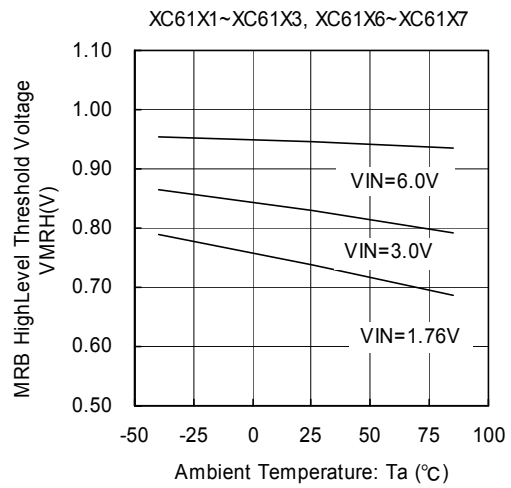
(13) Watchdog High Level Voltage vs. Ambient Temperature



(14) MRB Low Level Voltage vs. Ambient Temperature



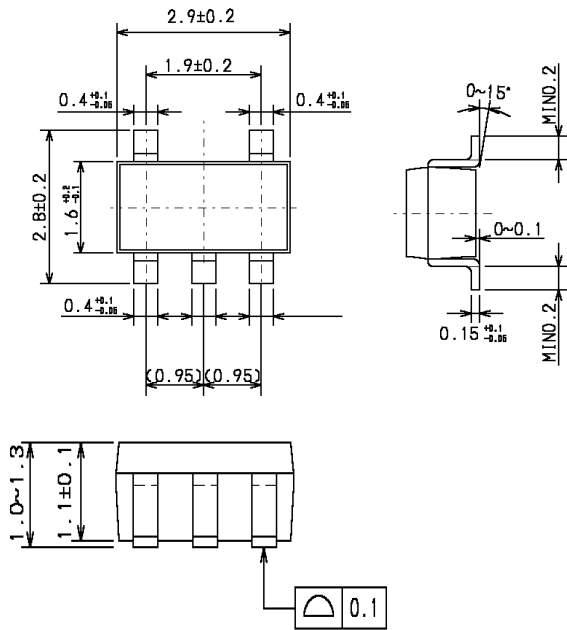
(15) MRB High Level Voltage vs. Ambient Temperature



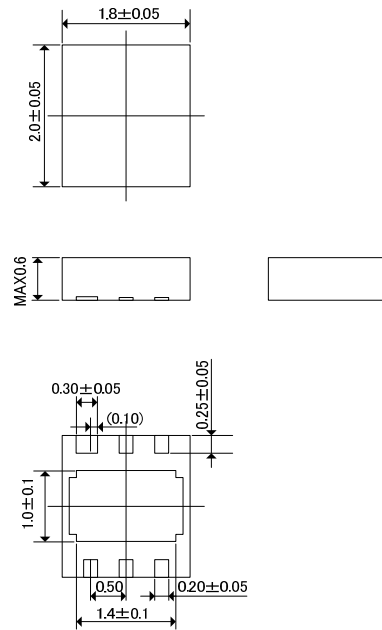
\* 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

# PACKAGING INFORMATION

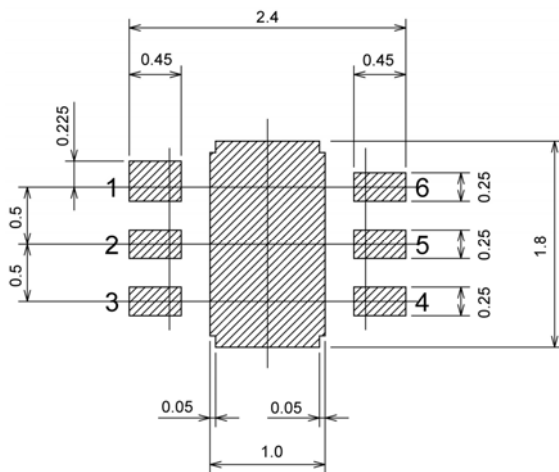
SOT-25



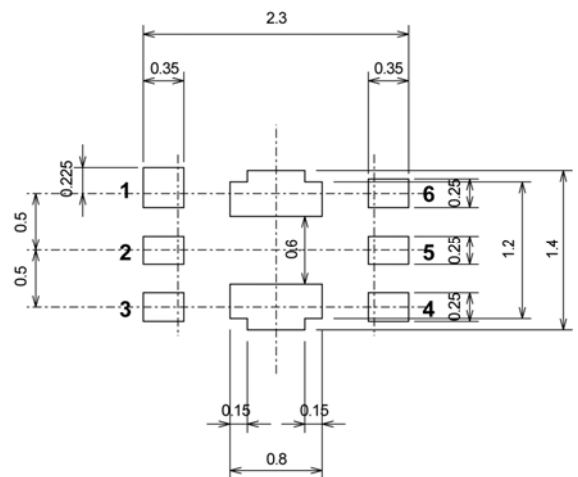
USP-6C



USP-6C Reference Pattern Layout

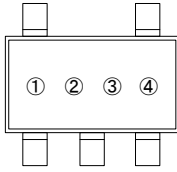


USP-6C Reference Metal Mask Design



## MARKING RULE

SOT-25



SOT-25  
(TOP VIEW)

represents product series

MARK	PRODUCT SERIES	MARK	PRODUCT SERIES
<u>0</u>	XC6101xxxxxx	<u>7</u>	XC6111xxxxxx
<u>1</u>	XC6102xxxxxx	<u>8</u>	XC6112xxxxxx
<u>2</u>	XC6103xxxxxx	<u>9</u>	XC6113xxxxxx
<u>3</u>	XC6104xxxxxx	<u>A</u>	XC6114xxxxxx
<u>4</u>	XC6105xxxxxx	<u>B</u>	XC6115xxxxxx
<u>5</u>	XC6106xxxxxx	<u>C</u>	XC6116xxxxxx
<u>6</u>	XC6107xxxxxx	<u>D</u>	XC6117xxxxxx

represents release delay time and watchdog timeout period

MARK	RELEASE DELAY TIME	WATCH DOG TIMEOUT PERIOD	PRODUCT SERIES	MARK	RELEASE DELAY TIME	WATCH DOG TIMEOUT PERIOD	PRODUCT SERIES
A	3.13ms	XC61X6, XC61X7 series	XC61xxA0xxxx	E	50ms	400ms	XC61xxC5xxxx
0	3.13ms	6.25ms	XC61xxA1xxxx	F	50ms	1.6s	XC61xxC6xxxx
1	3.13ms	50ms	XC61xxA2xxxx	D	100ms	XC61X6, XC61X7 series	XC61xxD0xxxx
2	3.13ms	100ms	XC61xxA3xxxx	H	100ms	100ms	XC61xxD3xxxx
3	3.13ms	200ms	XC61xxA4xxxx	K	100ms	200ms	XC61xxD4xxxx
4	3.13ms	400ms	XC61xxA5xxxx	L	100ms	400ms	XC61xxD5xxxx
5	3.13ms	1.6s	XC61xxA6xxxx	M	100ms	1.6s	XC61xxD6xxxx
B	25ms	XC61X6, XC61X7 series	XC61xxB0xxxx	E	200ms	XC61X6, XC61X7 series	XC61xxE0xxxx
6	25ms	50ms	XC61xxB2xxxx	P	200ms	200ms	XC61xxE4xxxx
7	25ms	100ms	XC61xxB3xxxx	R	200ms	400ms	XC61xxE5xxxx
8	25ms	200ms	XC61xxB4xxxx	S	200ms	1.6s	XC61xxE6xxxx
9	25ms	400ms	XC61xxB5xxxx	F	400ms	XC61X6, XC61X7 series	XC61xxF0xxxx
A	25ms	1.6s	XC61xxB6xxxx	T	400ms	400ms	XC61xxF5xxxx
C	50ms	XC61X6, XC61X7 series	XC61xxC0xxxx	U	400ms	1.6s	XC61xxF6xxxx
B	50ms	50ms	XC61xxC2xxxx	H	1.6s	XC61X6, XC61X7 series	XC61xxH0xxxx
C	50ms	100ms	XC61xxC3xxxx	V	1.6s	1.6s	XC61xxH6xxxx
D	50ms	200ms	XC61xxC4xxxx				

represents detect voltage  
XC6101/11/02/12/03/13/04/14/15/06/16/07/17Series

MARK	DETECT VOLTAGE	PRODUCT SERIES	MARK	DETECT VOLTAGE	PRODUCT SERIES
F	1.6	XC61Xxxx16xx	<u>3</u>	3.4	XC61Xxxx34xx
H	1.7	XC61Xxxx17xx	<u>4</u>	3.5	XC61Xxxx35xx
K	1.8	XC61Xxxx18xx	<u>5</u>	3.6	XC61Xxxx36xx
L	1.9	XC61Xxxx19xx	<u>6</u>	3.7	XC61Xxxx37xx
M	2.0	XC61Xxxx20xx	<u>7</u>	3.8	XC61Xxxx38xx
N	2.1	XC61Xxxx21xx	<u>8</u>	3.9	XC61Xxxx39xx
P	2.2	XC61Xxxx22xx	<u>9</u>	4.0	XC61Xxxx40xx
R	2.3	XC61Xxxx23xx	<u>A</u>	4.1	XC61Xxxx41xx
S	2.4	XC61Xxxx24xx	<u>B</u>	4.2	XC61Xxxx42xx
T	2.5	XC61Xxxx25xx	<u>C</u>	4.3	XC61Xxxx43xx
U	2.6	XC61Xxxx26xx	<u>D</u>	4.4	XC61Xxxx44xx
V	2.7	XC61Xxxx27xx	<u>E</u>	4.5	XC61Xxxx45xx
X	2.8	XC61Xxxx28xx	<u>F</u>	4.6	XC61Xxxx46xx
Y	2.9	XC61Xxxx29xx	<u>H</u>	4.7	XC61Xxxx47xx
Z	3.0	XC61Xxxx30xx	<u>K</u>	4.8	XC61Xxxx48xx
0	3.1	XC61Xxxx31xx	<u>L</u>	4.9	XC61Xxxx49xx
1	3.2	XC61Xxxx32xx	<u>M</u>	5.0	XC61Xxxx50xx
2	3.3	XC61Xxxx33xx			



## MARKING RULE (Continued)

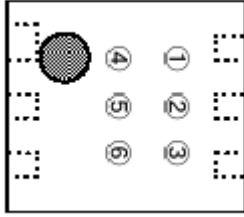
represents detect voltage  
XC6105 Series

MARK	DETECT VOLTAGE	PRODUCT SERIES	MARK	DETECT VOLTAGE	PRODUCT SERIES
F	1.6	XC6105XX16XX	3	3.4	XC6105XX34XX
H	1.7	XC6105XX17XX	4	3.5	XC6105XX35XX
K	1.8	XC6105XX18XX	5	3.6	XC6105XX36XX
L	1.9	XC6105XX19XX	6	3.7	XC6105XX37XX
M	2.0	XC6105XX20XX	7	3.8	XC6105XX38XX
N	2.1	XC6105XX21XX	8	3.9	XC6105XX39XX
P	2.2	XC6105XX22XX	9	4.0	XC6105XX40XX
R	2.3	XC6105XX23XX	<u>A</u>	4.1	XC6105XX41XX
S	2.4	XC6105XX24XX	<u>B</u>	4.2	XC6105XX42XX
T	2.5	XC6105XX25XX	<u>C</u>	4.3	XC6105XX43XX
U	2.6	XC6105XX26XX	<u>D</u>	4.4	XC6105XX44XX
V	2.7	XC6105XX27XX	<u>E</u>	4.5	XC6105XX45XX
X	2.8	XC6105XX28XX	<u>F</u>	4.6	XC6105XX46XX
Y	2.9	XC6105XX29XX	<u>H</u>	4.7	XC6105XX47XX
Z	3.0	XC6105XX30XX	<u>K</u>	4.8	XC6105XX48XX
0	3.1	XC6105XX31XX	<u>L</u>	4.9	XC6105XX49XX
1	3.2	XC6105XX32XX	<u>M</u>	5.0	XC6105XX50XX
2	3.3	XC6105XX33XX			

represents production lot number  
0 to 9 and A to Z and inverted 0 to 9 and A to Z repeated. (G, I, J, O, Q, W excluded.)

MARKING RULE (Continued)

USP-6C



USP-6C  
(TOP VIEW)

represents product series

MARK	PRODUCT SERIES	MARK	PRODUCT SERIES
3	XC6101xxxxxx	8	XC6111xxxxxx
4	XC6102xxxxxx	9	XC6112xxxxxx
5	XC6103xxxxxx	A	XC6113xxxxxx
6	XC6104xxxxxx	B	XC6114xxxxxx
7	XC6105xxxxxx	C	XC6115xxxxxx
3	XC6106xxxxxx	8	XC6116xxxxxx
4	XC6107xxxxxx	9	XC6117xxxxxx

represents release delay time

MARK	RELEASE DELAY TIME	PRODUCT SERIES
A	3.13ms	XC61XxAxxxxx
B	25ms	XC61XBxxxxx
C	50ms	XC61XCxxxxx
D	100ms	XC61XDxxxxx
E	200ms	XC61XExxxxx
F	400ms	XC61XFxxxxx
H	1.6s	XC61XHxxxxx

represents watchdog timeout period

MARK	WATCHDOG TIMEOUT PERIOD	PRODUCT SERIES
0	XC61X6, XC61X7 series	XC61Xxx0xxxx
1	6.25ms	XC61Xxx1xxxx
2	50ms	XC61Xxx2xxxx
3	100ms	XC61Xxx3xxxx
4	200ms	XC61Xxx4xxxx
5	400ms	XC61Xxx5xxxx
6	1.6s	XC61Xxx6xxxx

represents detect voltage

MARK		DETECT VOLTAGE (V)	PRODUCT SERIES
3	3	3.3	XC61Xxxx33xx
5	0	5.0	XC61Xxxx50xx

represents production lot number

0 to 9 and A to Z repeated. (G, I, J, O, Q, W excluded.)

X No character inversion used.

XX 'X' represents both '0' and '1'. (ex. XC61X1 XC6101 and XC6111)

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